

# LT E63C

## Power TOPLED® Lens

PowerTOPLED with lens, a powerful member of the TOPLED family. Thanks to their high luminous efficacy, the LEDs are ideal for rear light clusters and indicators on vehicles and for display panels for traffic control systems.



## Applications

- Electronic Equipment

## Features:

- Package: white PLCC-4 package, colorless clear resin
- Chip technology: InGaN
- Typ. Radiation: 20°
- Color:  $\lambda_{\text{dom}} = 525 \text{ nm}$  (● true green)
- Corrosion Robustness Class: 3B
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)

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## Ordering Information

| Type              | Partial Flux <sup>1)</sup><br>$I_F = 30 \text{ mA}$<br>$E_v$ | Ordering Code |
|-------------------|--------------------------------------------------------------|---------------|
| LT E63C-BADB-35-1 | 1800 ... 7100 lx                                             | Q65110A1981   |

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## Maximum Ratings

| Parameter                                                                            | Symbol    |      | Values |
|--------------------------------------------------------------------------------------|-----------|------|--------|
| Operating Temperature                                                                | $T_{op}$  | min. | -40 °C |
|                                                                                      |           | max. | 100 °C |
| Storage Temperature                                                                  | $T_{stg}$ | min. | -40 °C |
|                                                                                      |           | max. | 100 °C |
| Junction Temperature                                                                 | $T_j$     | max. | 125 °C |
| Forward current<br>$T_s = 25\text{ °C}$                                              | $I_F$     | max. | 30 mA  |
| Surge Current<br>$t \leq 10\text{ }\mu\text{s}$ ; $D = 0.005$ ; $T_s = 25\text{ °C}$ | $I_{FS}$  | max. | 400 mA |
| Reverse voltage <sup>2)</sup><br>$T_s = 25\text{ °C}$                                | $V_R$     | max. | 5 V    |
| ESD withstand voltage<br>acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)               | $V_{ESD}$ |      | 2 kV   |

## Characteristics

$I_F = 30 \text{ mA}$ ;  $T_S = 25^\circ\text{C}$

| Parameter                                                                                       | Symbol                              |                      | Values                                 |
|-------------------------------------------------------------------------------------------------|-------------------------------------|----------------------|----------------------------------------|
| Peak Wavelength                                                                                 | $\lambda_{\text{peak}}$             | typ.                 | 520 nm                                 |
| Dominant Wavelength <sup>3)</sup><br>$I_F = 30 \text{ mA}$                                      | $\lambda_{\text{dom}}$              | min.<br>typ.<br>max. | 516 nm<br>525 nm<br>534 nm             |
| Spectral Bandwidth at 50% $I_{\text{rel,max}}$                                                  | $\Delta\lambda$                     | typ.                 | 33 nm                                  |
| Viewing angle at 50 % $I_V$                                                                     | $2\phi$                             | typ.                 | $20^\circ$                             |
| Forward Voltage <sup>4)</sup><br>$I_F = 30 \text{ mA}$                                          | $V_F$                               | min.<br>typ.<br>max. | 2.90 V<br>3.50 V<br>4.40 V             |
| Reverse current <sup>2)</sup><br>$V_R = 5 \text{ V}$                                            | $I_R$                               | typ.<br>max.         | 0.01 $\mu\text{A}$<br>10 $\mu\text{A}$ |
| Temperature Coefficient of Peak Wavelength<br>$-10^\circ\text{C} \leq T \leq 100^\circ\text{C}$ | $\text{TC}_{\lambda_{\text{peak}}}$ | typ.                 | 0.04 nm / K                            |
| Real thermal resistance junction/ambient <sup>5), 6)</sup>                                      | $R_{\text{thJA real}}$              | max.                 | 350 K / W                              |
| Real thermal resistance junction/solderpoint <sup>5)</sup>                                      | $R_{\text{thJS real}}$              | max.                 | 180 K / W                              |

## Brightness Groups

| Group | Partial Flux <sup>1)</sup><br>$I_F = 30 \text{ mA}$<br>min.<br>$E_v$ | Partial Flux <sup>1)</sup><br>$I_F = 30 \text{ mA}$<br>max.<br>$E_v$ | Luminous Flux <sup>7)</sup><br>$I_F = 30 \text{ mA}$<br>typ.<br>$\Phi_v$ |
|-------|----------------------------------------------------------------------|----------------------------------------------------------------------|--------------------------------------------------------------------------|
| BA    | 1800 lx                                                              | 2240 lx                                                              | 1700 mlm                                                                 |
| BB    | 2240 lx                                                              | 2800 lx                                                              | 2100 mlm                                                                 |
| CA    | 2800 lx                                                              | 3550 lx                                                              | 2600 mlm                                                                 |
| CB    | 3550 lx                                                              | 4500 lx                                                              | 3300 mlm                                                                 |
| DA    | 4500 lx                                                              | 5600 lx                                                              | 4100 mlm                                                                 |
| DB    | 5600 lx                                                              | 7100 lx                                                              | 5200 mlm                                                                 |

For test method of partial flux measurement see Application Note: AN014 Partial flux — Measurement reliability of lensed LEDs

## Forward Voltage Groups

| Group | Forward Voltage <sup>4)</sup><br>$I_F = 30 \text{ mA}$<br>min.<br>$V_F$ | Forward Voltage <sup>4)</sup><br>$I_F = 30 \text{ mA}$<br>max.<br>$V_F$ |
|-------|-------------------------------------------------------------------------|-------------------------------------------------------------------------|
| 2     | 2.90 V                                                                  | 3.30 V                                                                  |
| 3     | 3.30 V                                                                  | 3.80 V                                                                  |
| 4     | 3.80 V                                                                  | 4.40 V                                                                  |

## Wavelength Groups

| Group | Dominant Wavelength <sup>3)</sup><br>$I_F = 30 \text{ mA}$<br>min.<br>$\lambda_{\text{dom}}$ | Dominant Wavelength <sup>3)</sup><br>$I_F = 30 \text{ mA}$<br>max.<br>$\lambda_{\text{dom}}$ |
|-------|----------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------|
| 3     | 516 nm                                                                                       | 522 nm                                                                                       |
| 4     | 522 nm                                                                                       | 528 nm                                                                                       |
| 5     | 528 nm                                                                                       | 534 nm                                                                                       |

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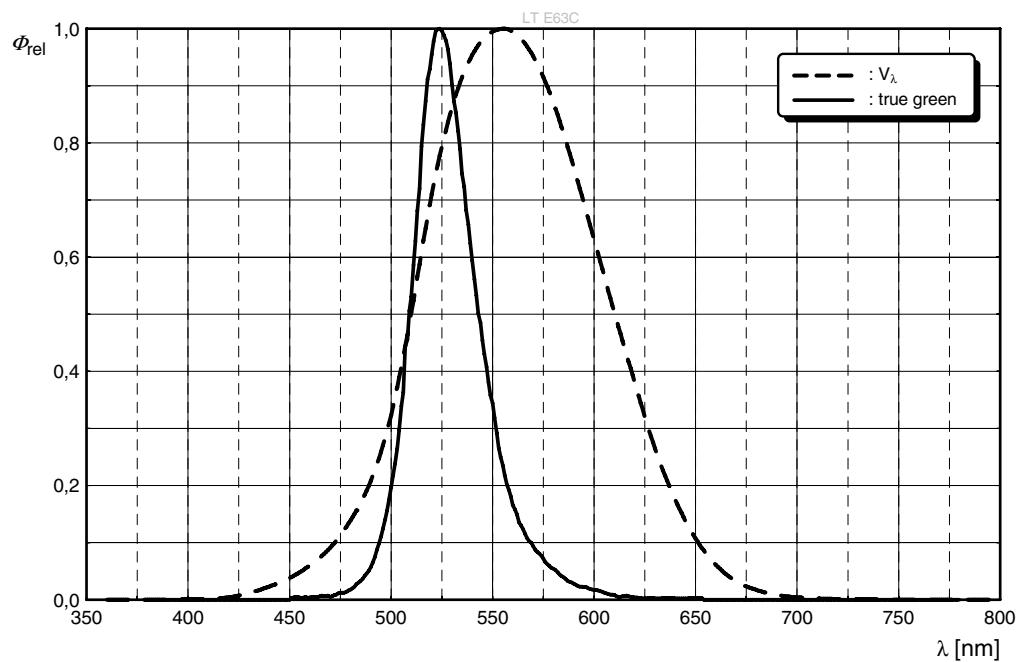
## Group Name on Label

**Example: BA-3-2**

| Brightness | Wavelength | Forward Voltage |
|------------|------------|-----------------|
| BA         | 3          | 2               |

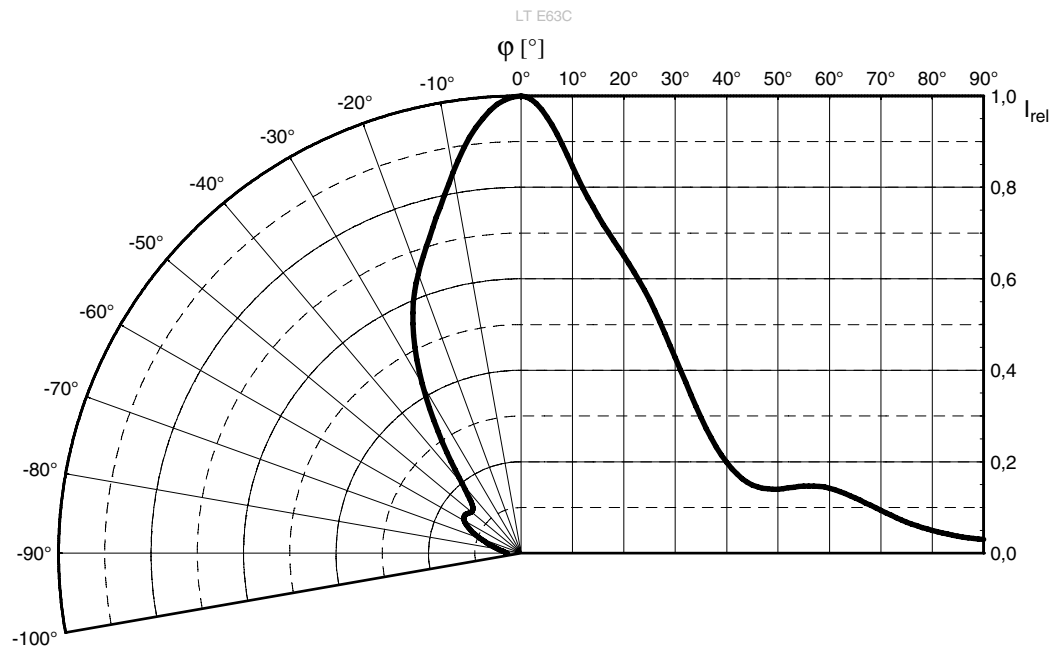
## Relative Spectral Emission <sup>7)</sup>

$I_{\text{rel}} = f(\lambda); I_F = 30 \text{ mA}; T_S = 25 \text{ °C}$



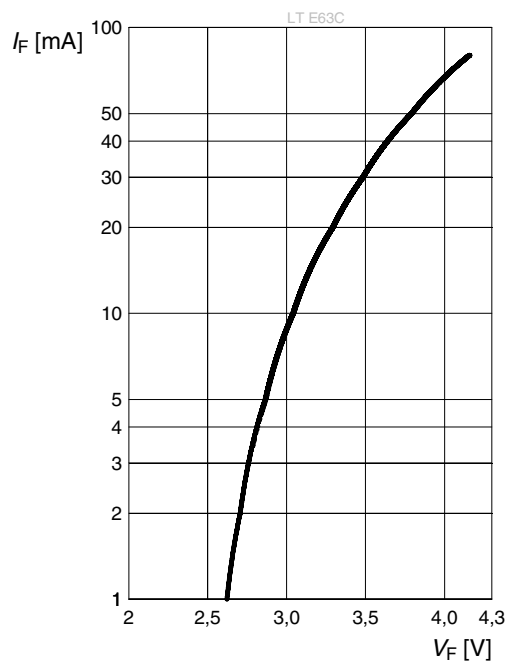
## Radiation Characteristics <sup>7)</sup>

$I_{\text{rel}} = f(\phi); T_S = 25 \text{ °C}$

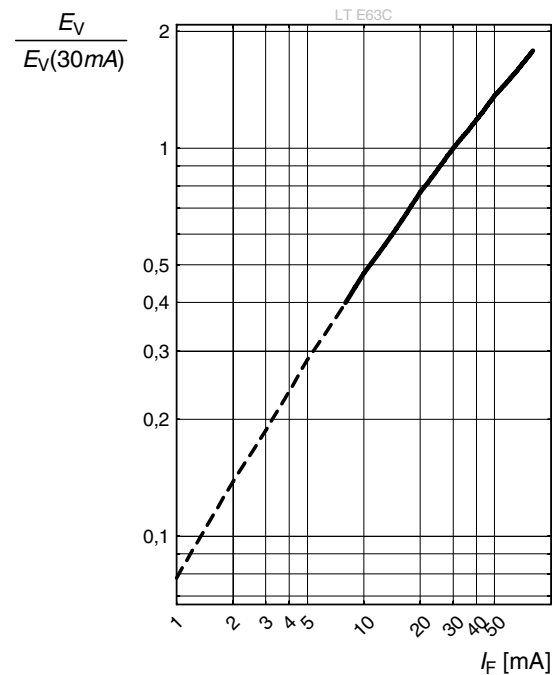


**Forward current** <sup>7), 8)</sup>

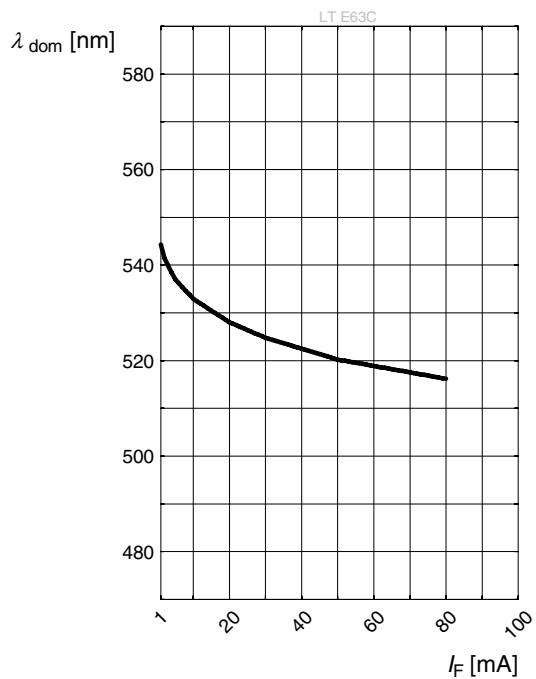
$$I_F = f(V_F); T_S = 25\text{ °C}$$

**Relative Partial Flux** <sup>7), 8)</sup>

$$E_V/E_V(30\text{ mA}) = f(I_F); T_S = 25\text{ °C}$$

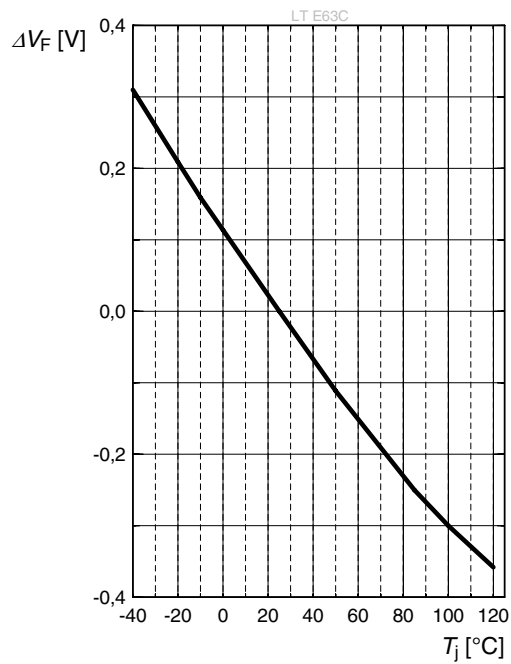
**Dominant Wavelength** <sup>7)</sup>

$$\lambda_{\text{dom}} = f(I_F); T_S = 25\text{ °C}$$

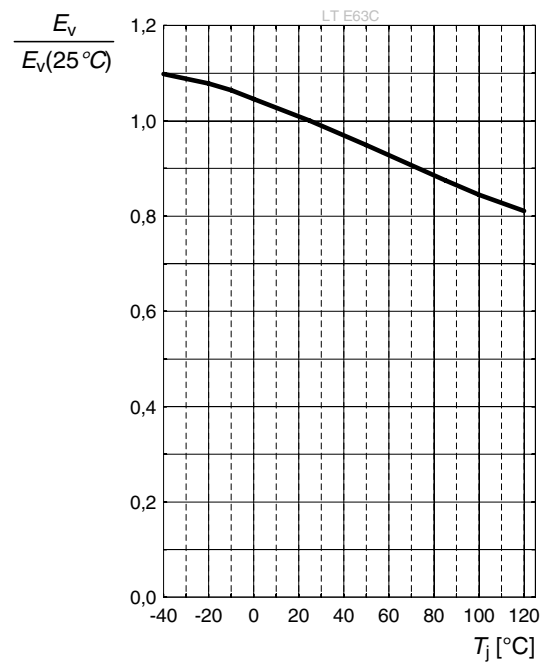


**Forward Voltage** <sup>7)</sup>

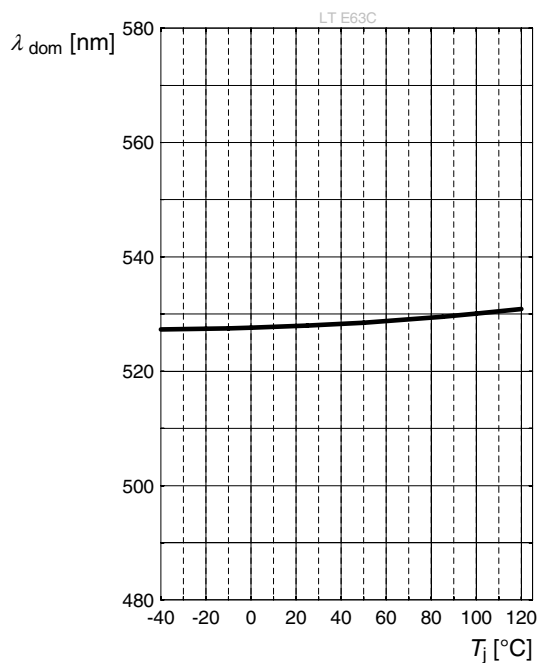
$$\Delta V_F = V_F - V_F(25^\circ\text{C}) = f(T_j); I_F = 30\text{ mA}$$

**Relative Partial Flux** <sup>7)</sup>

$$E_v/E_v(25^\circ\text{C}) = f(T_j); I_F = 30\text{ mA}$$

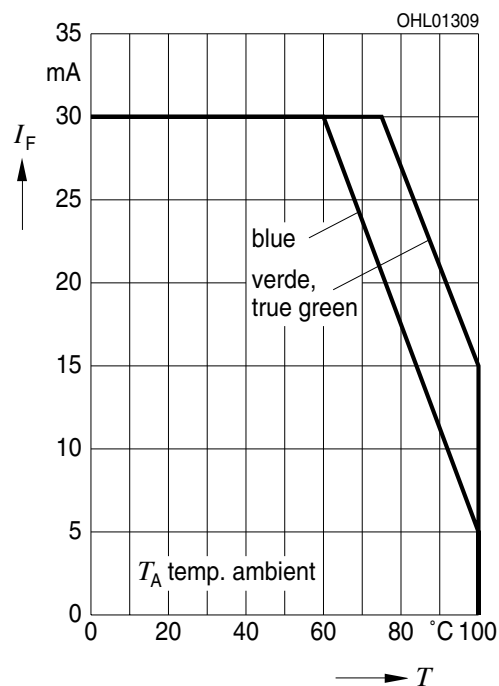
**Dominant Wavelength** <sup>7)</sup>

$$\lambda_{\text{dom}} = f(T_j); I_F = 30\text{ mA}$$



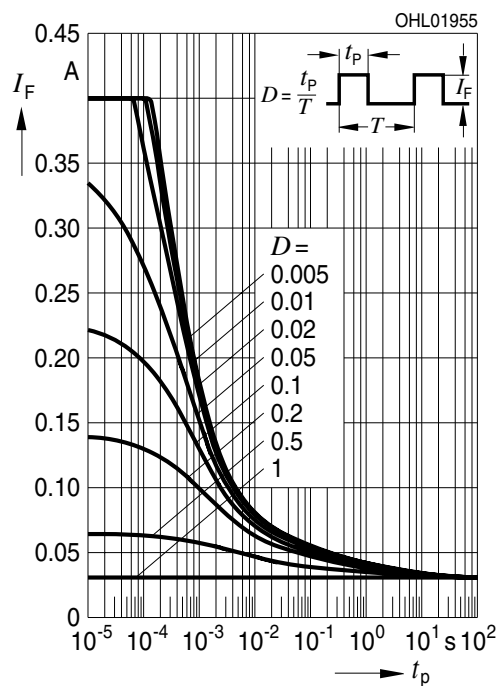
## Max. Permissible Forward Current

$$I_F = f(T)$$



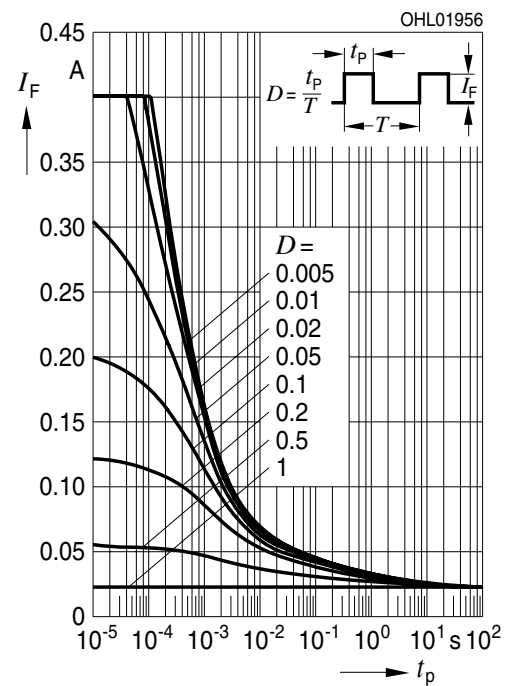
## Permissible Pulse Handling Capability

$$I_F = f(t_p); D: \text{Duty cycle}; T_S = 25^\circ\text{C}$$

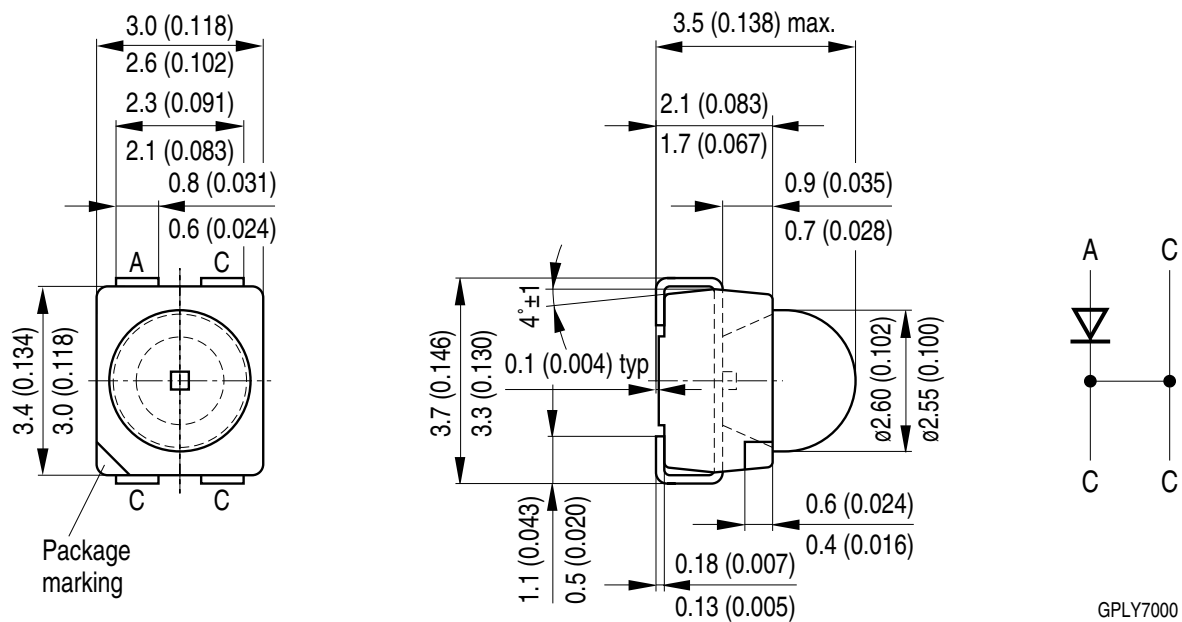


## Permissible Pulse Handling Capability

$$I_F = f(t_p); D: \text{Duty cycle}; T_S = 85^\circ\text{C}$$



## Dimensional Drawing <sup>9)</sup>

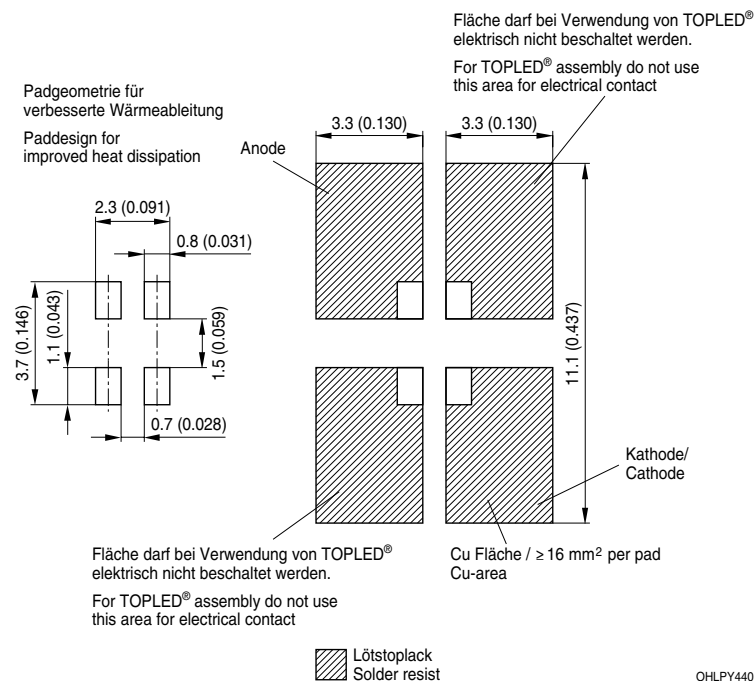


**Approximate Weight:** 38.0 mg

**Package marking:** Cathode

**Corrosion test:** Class: 3B  
 Test condition: 40°C / 90 % RH / 15 ppm H<sub>2</sub>S / 14 days (stricter than IEC 60068-2-43)

## Recommended Solder Pad <sup>9)</sup>



For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for ultra sonic cleaning.

## Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E

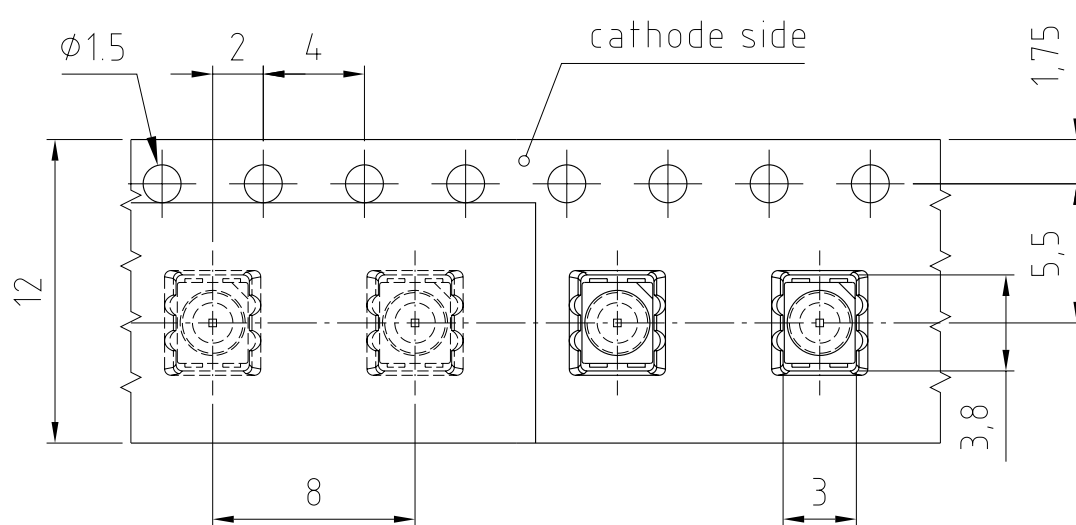


| Profile Feature                                                   | Symbol | Pb-Free (SnAgCu) Assembly |                |         | Unit |
|-------------------------------------------------------------------|--------|---------------------------|----------------|---------|------|
|                                                                   |        | Minimum                   | Recommendation | Maximum |      |
| Ramp-up rate to preheat*)<br>25 °C to 150 °C                      |        |                           | 2              | 3       | K/s  |
| Time $t_s$<br>$T_{Smin}$ to $T_{Smax}$                            | $t_s$  | 60                        | 100            | 120     | s    |
| Ramp-up rate to peak*)<br>$T_{Smax}$ to $T_p$                     |        |                           | 2              | 3       | K/s  |
| Liquidus temperature                                              | $T_L$  |                           | 217            |         | °C   |
| Time above liquidus temperature                                   | $t_L$  |                           | 80             | 100     | s    |
| Peak temperature                                                  | $T_p$  |                           | 245            | 250     | °C   |
| Time within 5 °C of the specified peak<br>temperature $T_p - 5$ K | $t_p$  | 10                        | 20             | 30      | s    |
| Ramp-down rate*<br>$T_p$ to 100 °C                                |        |                           | 3              | 4       | K/s  |
| Time<br>25 °C to $T_p$                                            |        |                           |                | 480     | s    |

All temperatures refer to the center of the package, measured on the top of the component

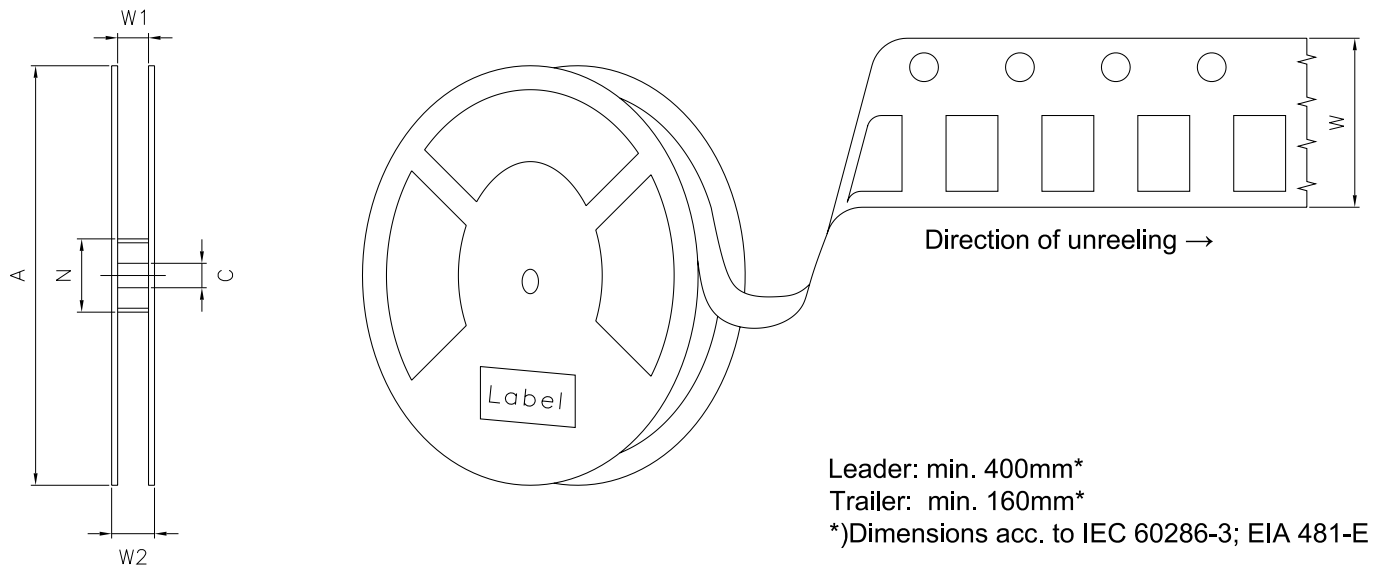
\* slope calculation  $DT/Dt$ :  $Dt$  max. 5 s; fulfillment for the whole T-range

## Taping <sup>9)</sup>



C63062-A3533-B01-02

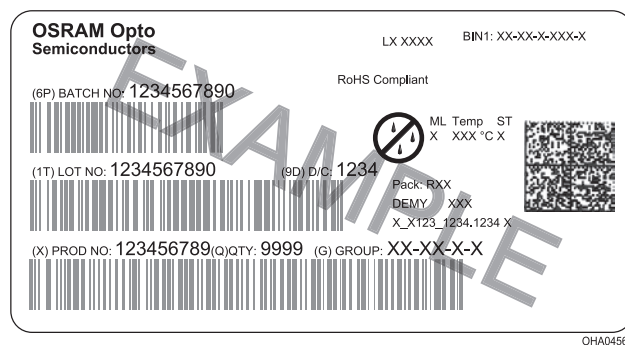
## Tape and Reel <sup>10)</sup>



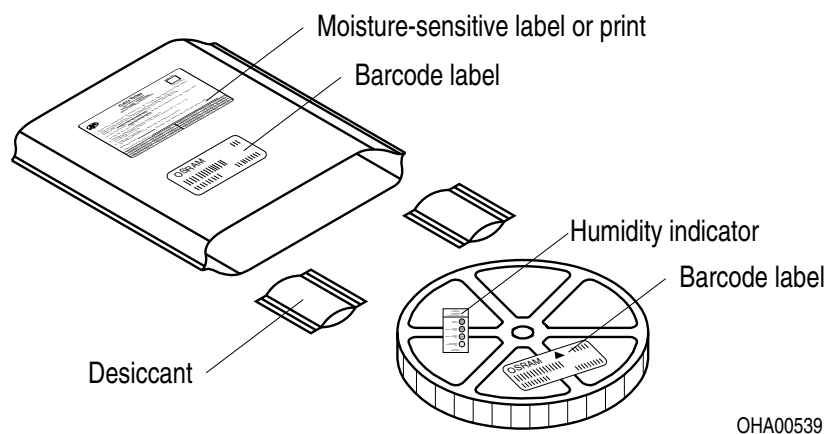
## Reel dimensions [mm]

| A      | W                | N <sub>min</sub> | W <sub>1</sub> | W <sub>2 max</sub> | Pieces per PU |
|--------|------------------|------------------|----------------|--------------------|---------------|
| 330 mm | 12 + 0.3 / - 0.1 | 60               | 12.4 + 2       | 18.4               | 2000          |

## Barcode-Product-Label (BPL)

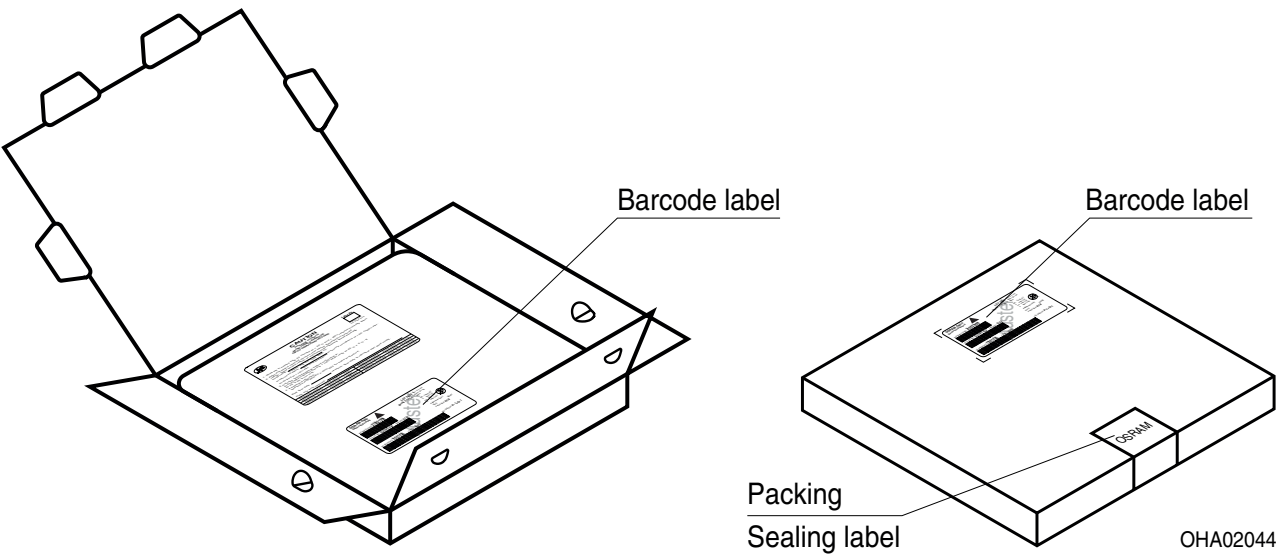


## Dry Packing Process and Materials <sup>9)</sup>



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

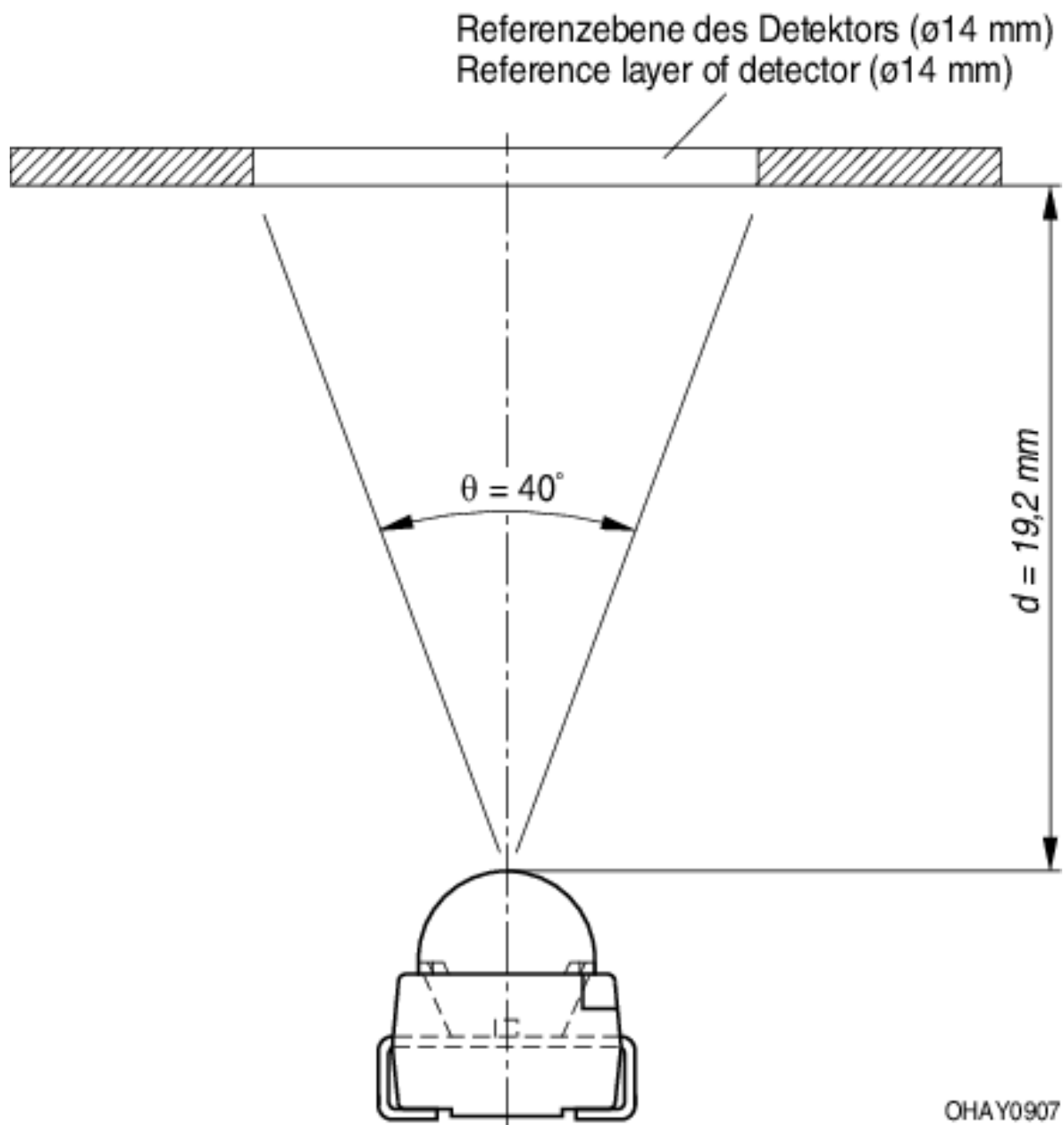
Transportation Packing and Materials <sup>9)</sup>



Dimensions of transportation box in mm

| Width      | Length     | Height    |
|------------|------------|-----------|
| 349 ± 5 mm | 349 ± 5 mm | 33 ± 5 mm |

## Schematic test method for partial flux measurement



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## Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the LED specified in this data sheet fall into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. As is also true when viewing other bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this LED contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize LED exposure to aggressive substances during storage, production, and use. LEDs that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related informations please visit [www.osram-os.com/appnotes](http://www.osram-os.com/appnotes)

## Disclaimer

### Disclaimer

Language english will prevail in case of any discrepancies or deviations between the two language wordings.

### Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

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### Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office.

By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

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## Glossary

- 1) **Brightness:** Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of  $\pm 8\%$  and an expanded uncertainty of  $\pm 11\%$  (acc. to GUM with a coverage factor of  $k = 3$ ).
- 2) **Reverse Operation:** Reverse Operation of 10 hours is permissible in total. Continuous reverse operation is not allowed.
- 3) **Wavelength:** The wavelength is measured at a current pulse of typically 25 ms, with an internal reproducibility of  $\pm 0.5\text{ nm}$  and an expanded uncertainty of  $\pm 1\text{ nm}$  (acc. to GUM with a coverage factor of  $k = 3$ ).
- 4) **Forward Voltage:** The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of  $\pm 0.05\text{ V}$  and an expanded uncertainty of  $\pm 0.1\text{ V}$  (acc. to GUM with a coverage factor of  $k = 3$ ).
- 5) **Thermal Resistance:**  $R_{th\text{ max}}$  is based on statistic values ( $6\sigma$ ).
- 6) **Thermal Resistance:**  $R_{thJA}$  results from mounting on PC board FR 4 (pad size  $16\text{ mm}^2$  per pad)
- 7) **Typical Values:** Due to the special conditions of the manufacturing processes of LED, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 8) **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single LEDs within one packing unit.
- 9) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with  $\pm 0.1$  and dimensions are specified in mm.
- 10) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

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EU RoHS and China RoHS compliant product



此产品符合欧盟 RoHS 指令的要求；  
按照中国的相关法规和标准，不含有毒有害物质或元素。

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Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

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Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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